Precision quad operational amplifier

Datasheet — production data

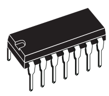
Features

- Low input offset voltage: 500 µV max.
- Low power consumption
- Short-circuit protection
- Low distortion, low noise
- High gain bandwidth product
- High channel separation
- ESD protection 2 kV

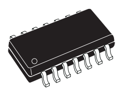
Description

The TS514 device is a high-performance quad operational amplifier with frequency and phase compensation built into the chip. The internal phase compensation allows stable operation as a voltage follower in spite of its high gain bandwidth.

The circuit presents very stable electrical characteristics over the entire supply voltage range, and is particularly intended for professional and telecom applications (such as active filters, for example).

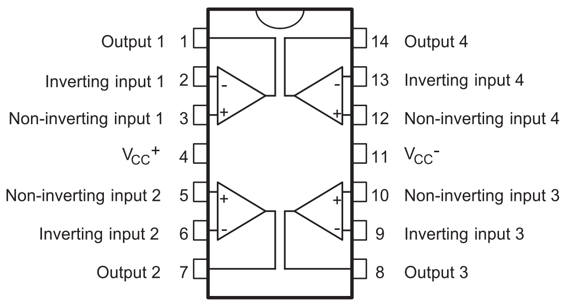


N
DIP14
(plastic package)



D
SO-14
(plastic micropackage)

Pin connections
(top view)



1 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	±18	V
V_i	Input voltage	V_{DD}-0.2 to V_{CC}+0.2	V
V_{id}(1)	Differential input voltage	$\pm V_{CC}$	V
T_{stg}	Storage temperature range	-65 to +150	°C
R_{thja}	Thermal resistance junction-to-ambient SO-14 DIP14	 103 80	°C/W
R_{thjc}	Thermal resistance junction-to-case SO-14 DIP14	 31 33	°C/W
ESD	HBM: human body model(2)	2	kV
	MM: machine model(3)	200	V
	CDM: charged device model(4)	1.5	kV

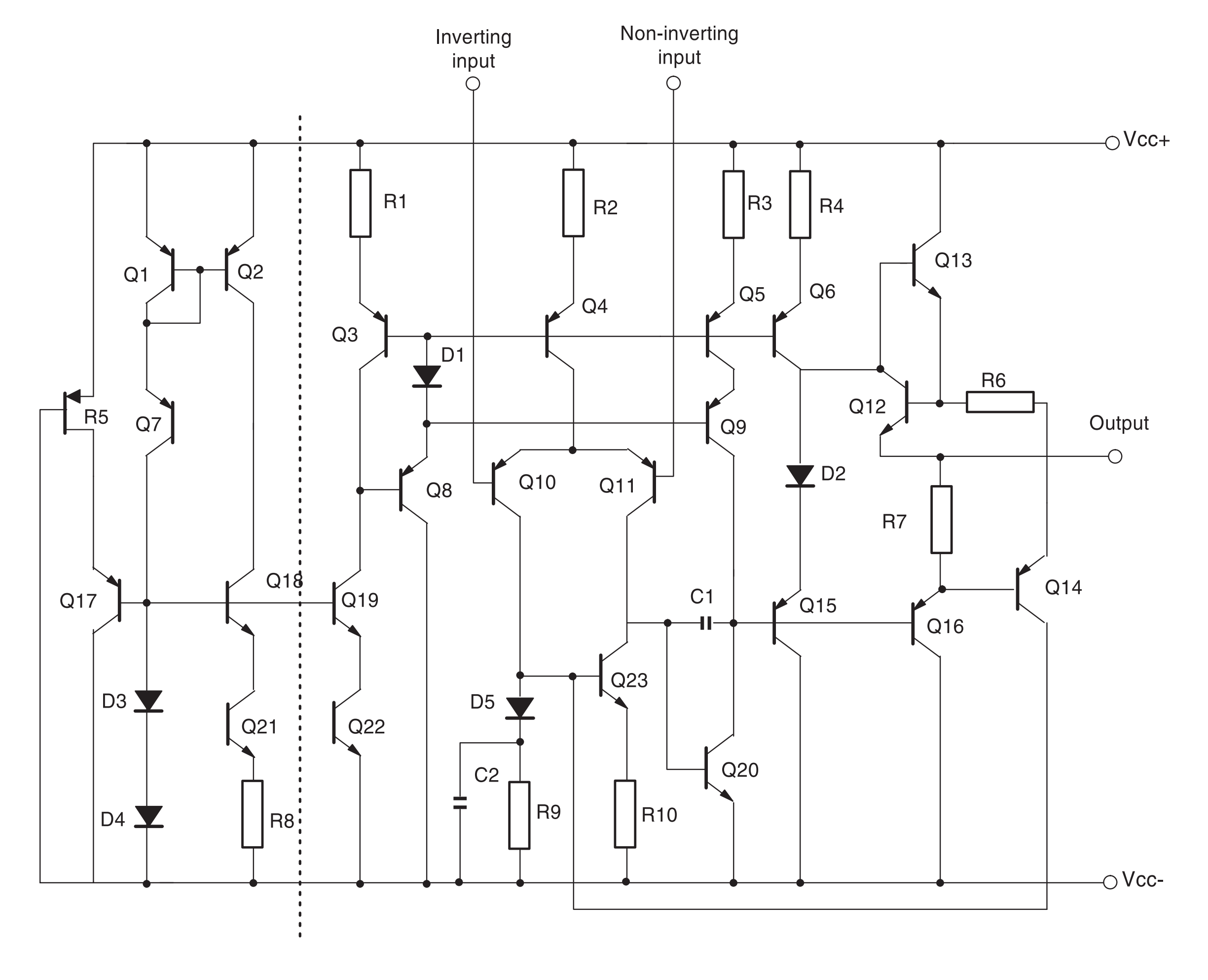
1. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal.
2. Human body model: a 100 pF capacitor is charged to the specified voltage, then discharged through a 1.5kΩ resistor between two pins of the device. This is done for all couples of connected pin combinations while the other pins are floating.
3. Machine model: a 200 pF capacitor is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor < 5 Ω). This is done for all couples of connected pin combinations while the other pins are floating.
4. Charged device model: all pins and the package are charged together to the specified voltage and then discharged directly to ground through only one pin. This is done for all pins.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	6 to 30	V
V_{icm}	Common mode input voltage range	V_{DD} +0.8 to V_{CC} -1.5	V
T_{oper}	Operating free air temperature range	-40 to +125	°C

2 Schematic diagram

Figure 1. Typical schematic diagram (1/4 TS514)



3 Electrical characteristics

Table 3. Electrical characteristics at V_{CC} = ±15 V, T_{amb} = 25 °C (unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit
I_{CC}	Supply current (per operator) at $T_{min} \le T_{op} \le T_{max}$		0.5	0.6 0.75	mA
I_{ib}	Input bias current – at 25 °C – at $T_{min} \le T_{op} \le T_{max}$		50	150 300	nA
R_i	Input resistance, F= 1 kHz		1		MΩ
V_{io}	Input offset voltage – at 25 °C TS514 TS514A – at $T_{min} \le T_{op} \le T_{max}$ TS514 TS514A		0.5	2.5 0.5 4 1.5	mV
ΔV_{io}	Input offset voltage drift at $T_{min} \le T_{op} \le T_{max}$		5		µV/°C
I_{io}	Input offset current at 25 °C at $T_{min} \le T_{op} \le T_{max}$		5	20 40	nA
ΔI_{io}	Input offset current drift $T_{min} \le T_{op} \le T_{max}$		0.08		$\frac{nA}{°C}$
I_{os}	Output short-circuit current		23		mA
A_{vd}	Large signal voltage gain, R_L = 2 kΩ V_{CC} = ±15 V, at $T_{min} \le T_{op} \le T_{max}$ V_{CC} = ± 4 V	90	100 95		dB
GBP	Gain bandwidth product, F = 100 kHz	1.8	3		MHz
e_n	Equivalent input noise voltage, F = 1 kHz Rs = 50 Ω Rs = 1 kΩ Rs = 10 kΩ		8 10 18	15	$\frac{nV}{\sqrt{Hz}}$
THD	Total harmonic distortion A_v = 20 dB, R_L = 2 kΩ, V_o = 2 V_{pp}, f = 1 kHz		0.03	0.1	%
$\pm V_{opp}$	Output voltage swing, R_L = 2 kΩ V_{CC} = ±15 V, at $T_{min} \le T_{op} \le T_{max}$ V_{CC} = ± 4 V	±13	 ±3		V
V_{opp}	Large signal voltage swing, R_L = 10 kΩ, F = 10 kHz		28		V_{pp}
SR	Slew rate, unity gain, R_L = 2 kΩ	0.8	1.5		V/µs

Table 3. Electrical characteristics at V_{CC} = ±15 V, T_{amb} = 25 °C (unless otherwise specified) (continued)

Symbol	Parameter	Min.	Typ.	Max.	Unit
CMR	Common mode rejection ratio CMR = 20 log ($\Delta V_{ic}/\Delta V_{io}$) ($V_{ic}$ = -10 V to 10 V, V_{out} = V_{CC}/2, R_L > 1 MΩ)	90			dB
SVR	Supply voltage rejection ratio 20 log ($\Delta V_{CC}/\Delta V_{io}$) ($V_{CC}$ = ±5 V to ±15 V, V_{out} = V_{icm} = V_{CC}/2)	90			dB
V_{o1}/V_{o2}	Channel separation, F = 1 kHz		120		dB

Figure 2. V_{io} distribution at $V_{CC} = \pm15$ V and T = 25 °C

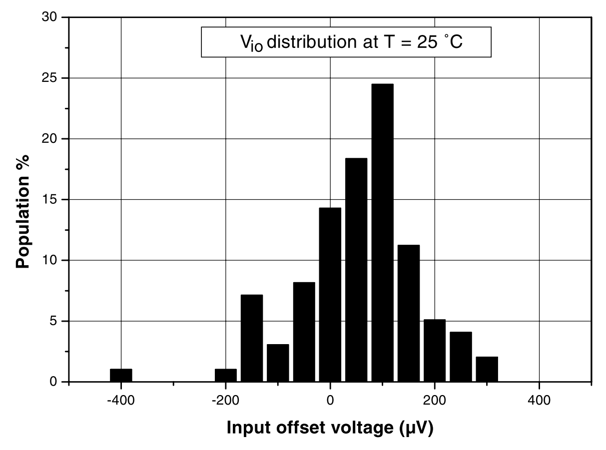


Figure 3. V_{io} distribution at $V_{CC} = \pm15$ V and T = 125 °C

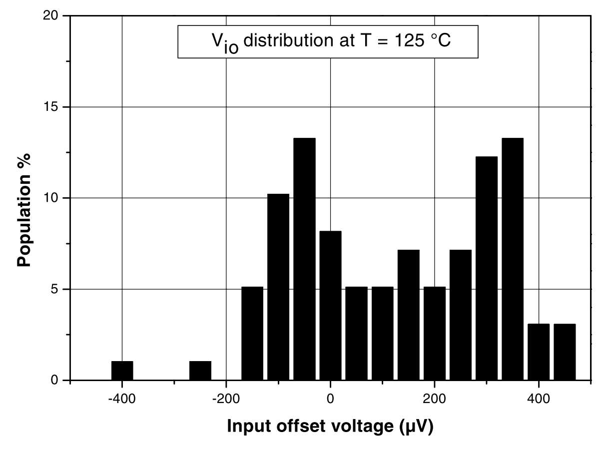


Figure 4. Input offset voltage vs. supply voltage at $V_{icm} = V_{CC}/2$

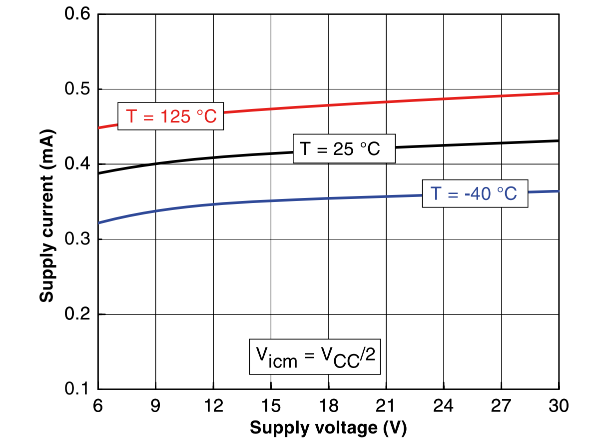


Figure 5. Input offset voltage vs. input common mode voltage at V_{CC} = 6 V

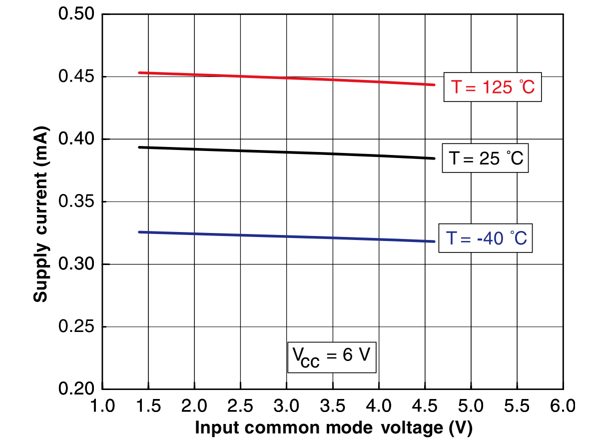


Figure 6. Input offset voltage vs. input common mode voltage at V_{CC} = 10 V

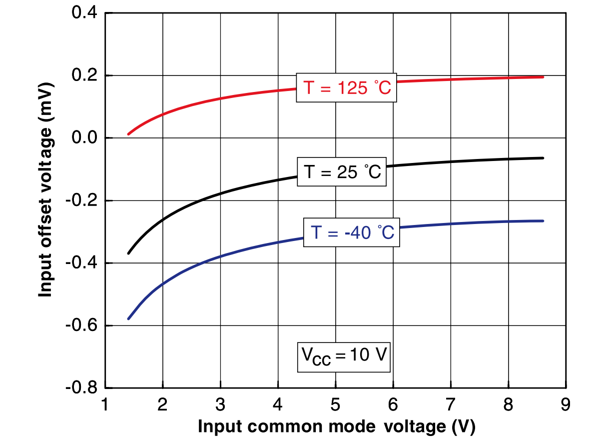


Figure 7. Input offset voltage vs. input common mode voltage at V_{CC} = 30 V

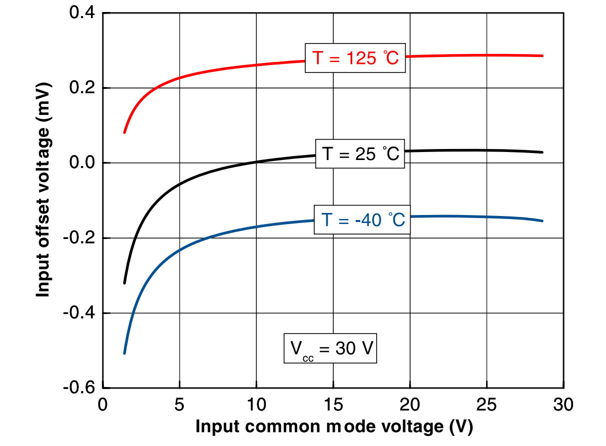


Figure 8. Supply current (per operator) vs. supply voltage at $V_{icm} = V_{CC}/2$

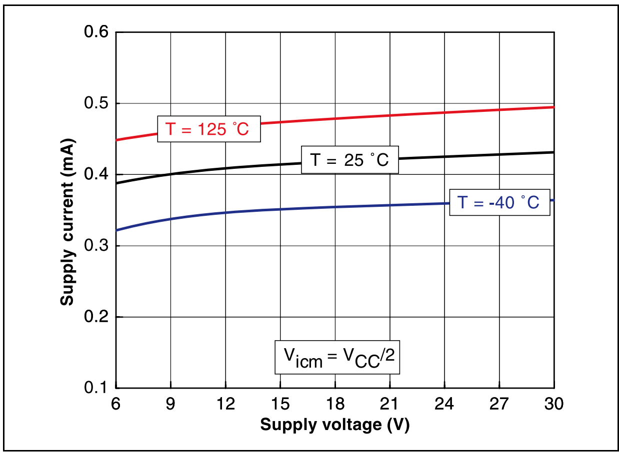


Figure 9. Supply current (per operator) vs. input common mode voltage at V_{CC} = 6 V

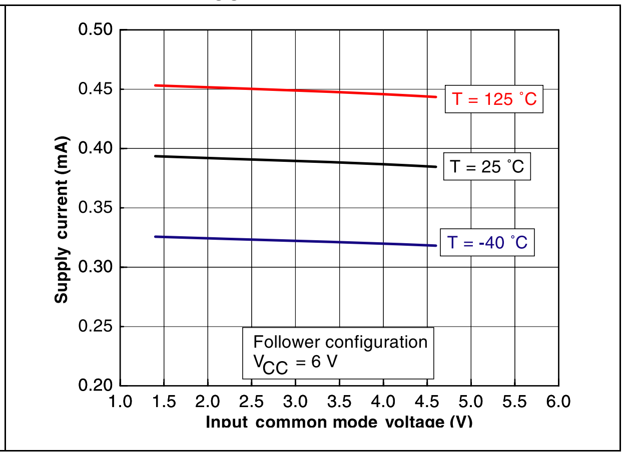


Figure 10. Supply current (per operator) vs. input common mode voltage at V_{CC} = 10 V

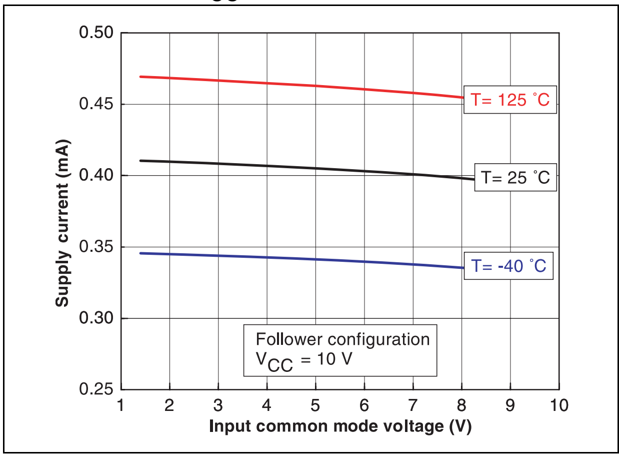


Figure 11. Supply current (per operator) vs. input common mode voltage at V_{CC} = 30 V

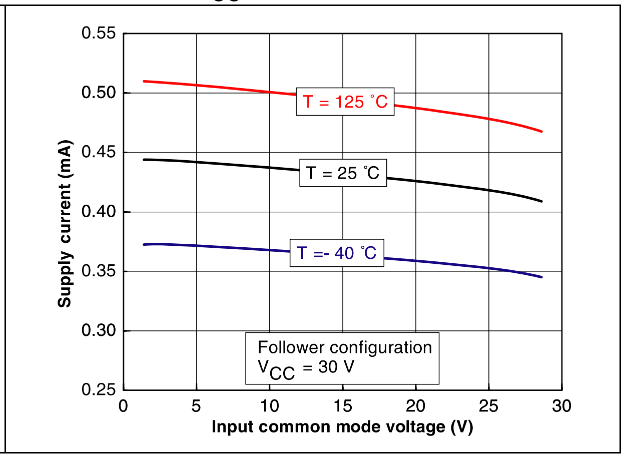


Figure 12. Output current vs. supply voltage at $V_{icm} = V_{CC}/2$

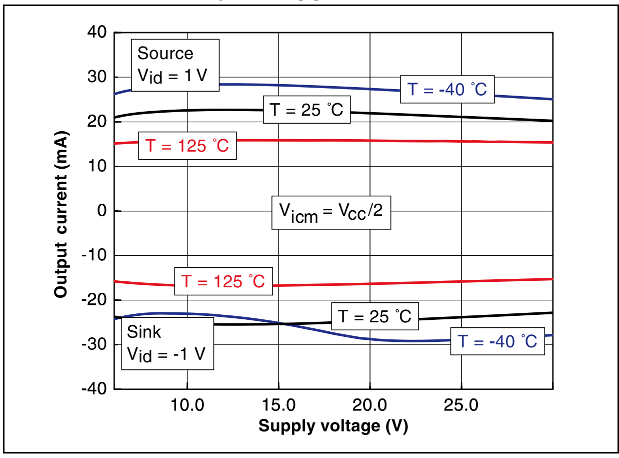


Figure 13. Output current vs. output voltage at V_{CC} = 6 V

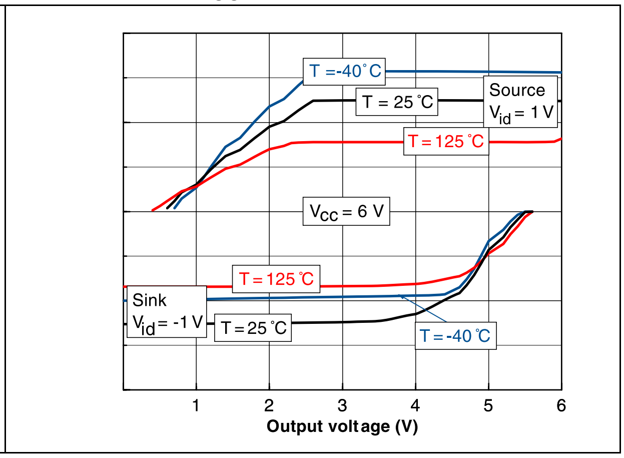


Figure 14. Output current vs. output voltage at V_{CC} = 10 V

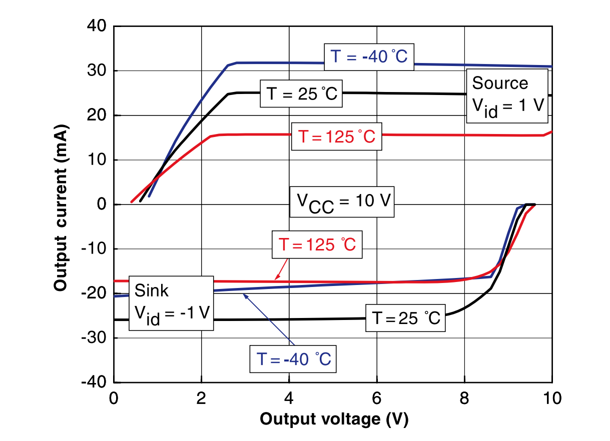


Figure 15. Output current vs. output voltage at V_{CC} = 30 V

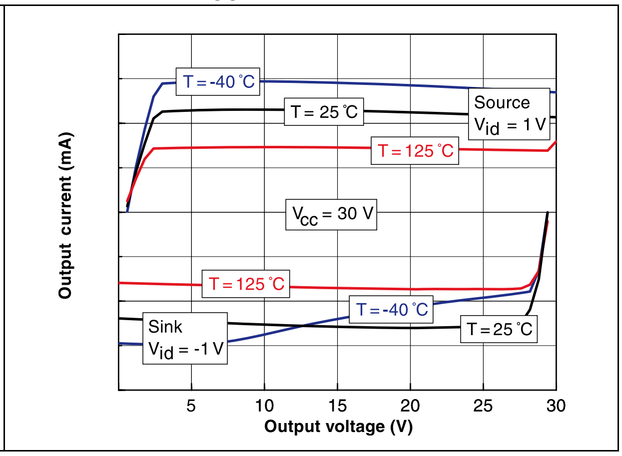


Figure 16. Voltage gain and phase for different capacitive load at V_{CC} = 6 V, V_{icm} = 3 V and T = 25 °C

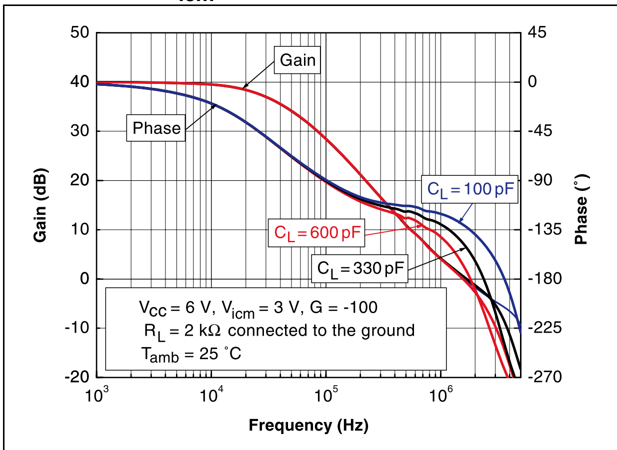


Figure 17. Voltage gain and phase for different capacitive load at V_{CC} = 10 V, V_{icm} = 5 V and T = 25 °C

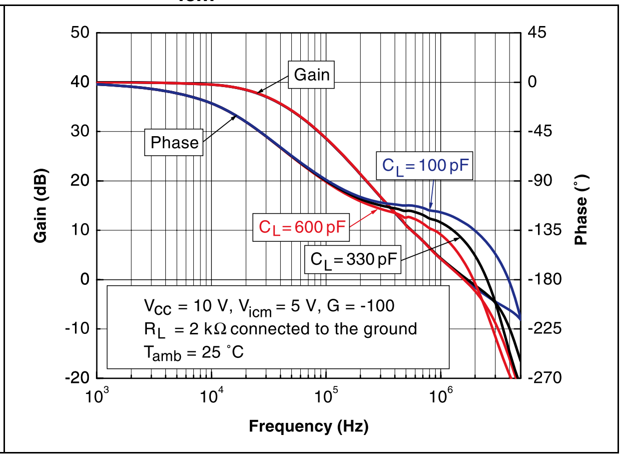


Figure 18. Voltage gain and phase for different capacitive load at V_{CC} = 30 V, V_{icm} = 15 V and T = 25 °C

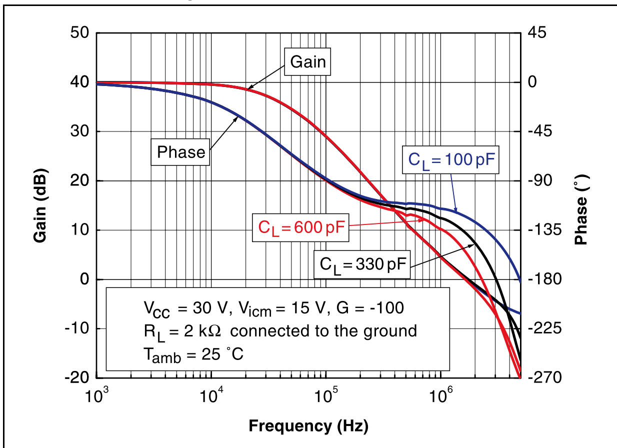


Figure 19. Frequency response for different capacitive load at V_{CC} = 6 V, V_{icm} = 3 V and T = 25 °C

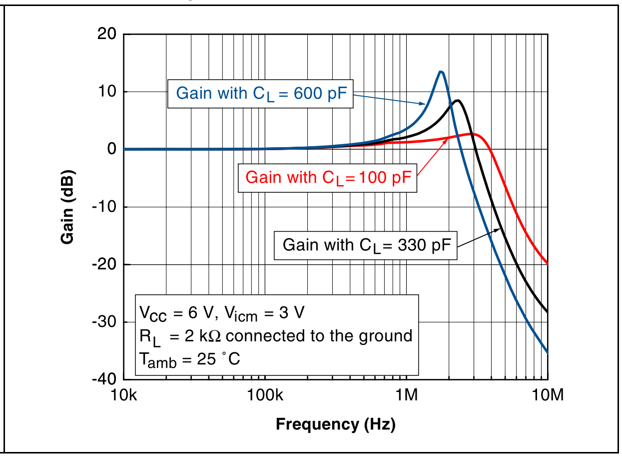


Figure 20. Frequency response for different capacitive load at V_{CC}= 10 V, V_{icm} = 5 V and T = 25 °C

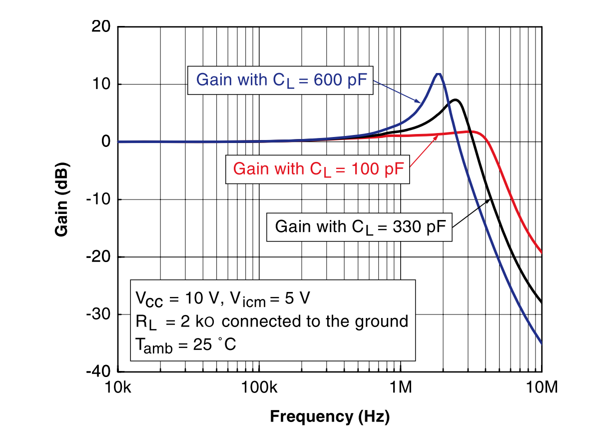


Figure 21. Frequency response for different capacitive load at V_{CC} = 30 V, V_{icm} = 15 V and T = 25 °C

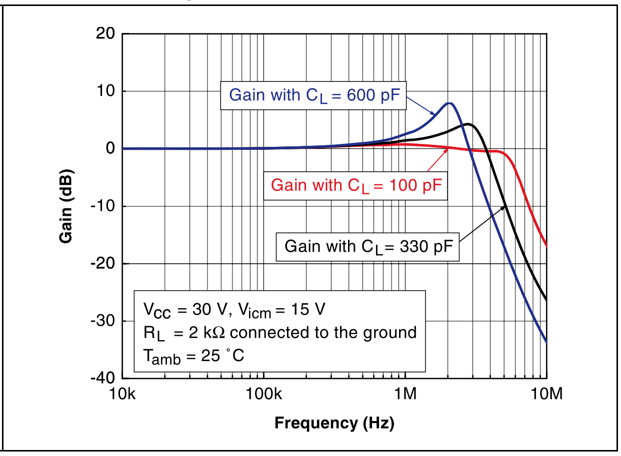


Figure 22. Gain margin vs. output current, at V_{CC} = 6 V, V_{icm} = 3 V and T = 25 °C

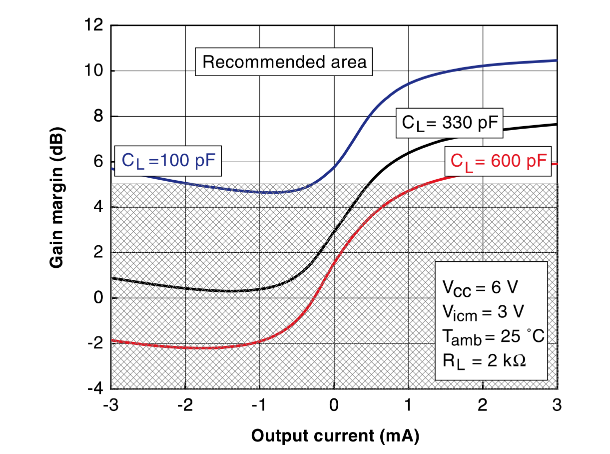


Figure 23. Gain margin vs. output current, at V_{CC} = 10 V, V_{icm} = 5 V and T = 25 °C

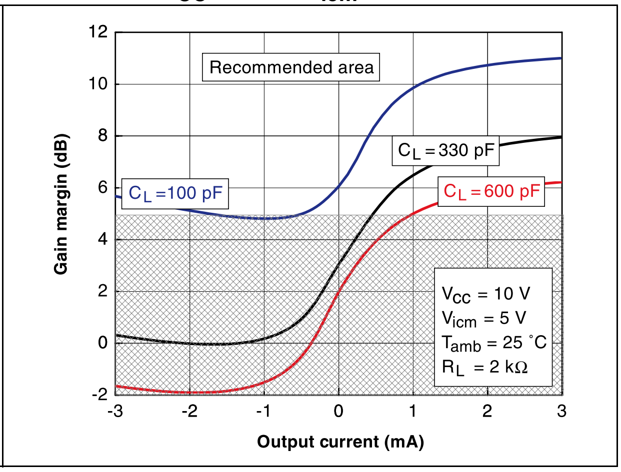


Figure 24. Gain margin vs. output current, at V_{CC} = 30 V, V_{icm} = 15 V and T = 25 °C

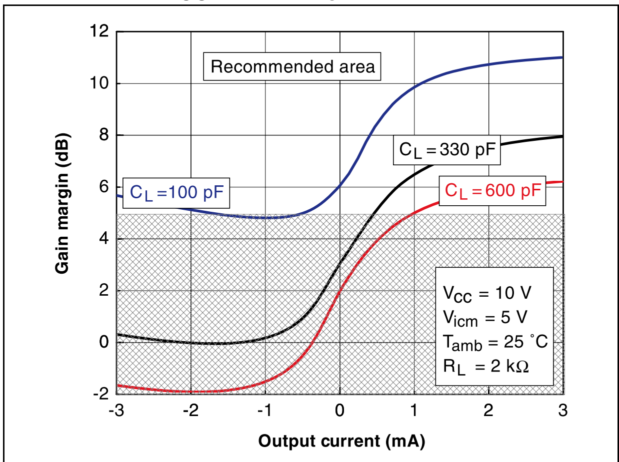


Figure 25. Phase margin vs. output current, at V_{CC} = 6 V, V_{icm} = 3 V and T = 25 °C

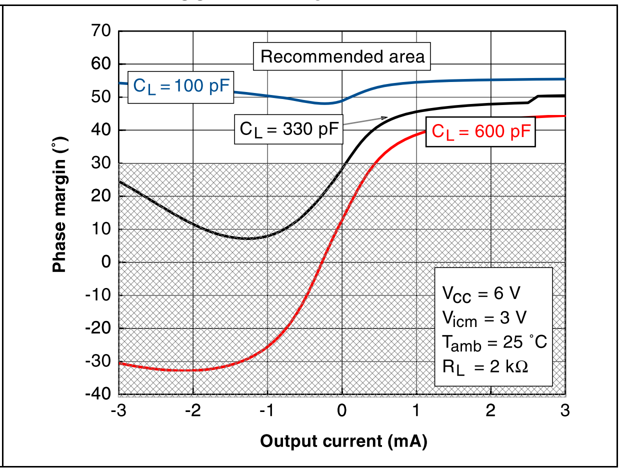


Figure 26. Phase margin vs. output current, at V_{CC} = 10 V, V_{icm} = 5 V and T = 25 °C

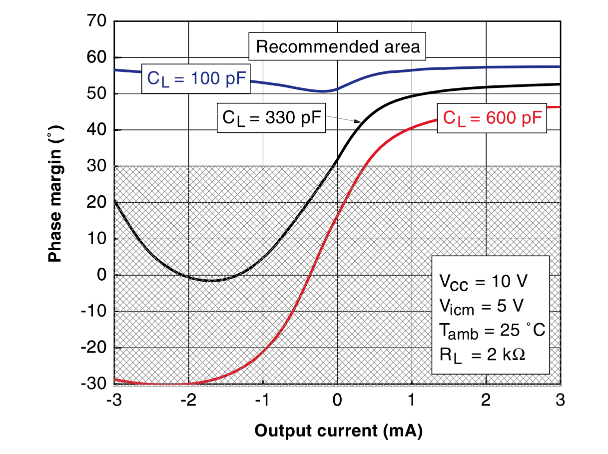
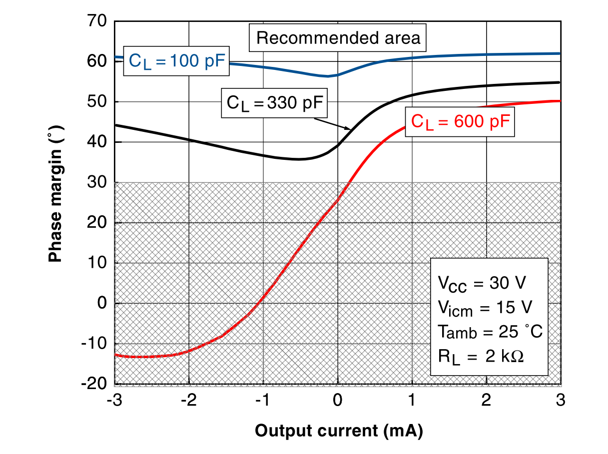


Figure 27. Phase margin vs. output current, at V_{CC} = 30 V, V_{icm} = 15 V and T = 25 °C



4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK is an ST trademark.

4.1 DIP14 package information

Figure 28. DIP14 package outline

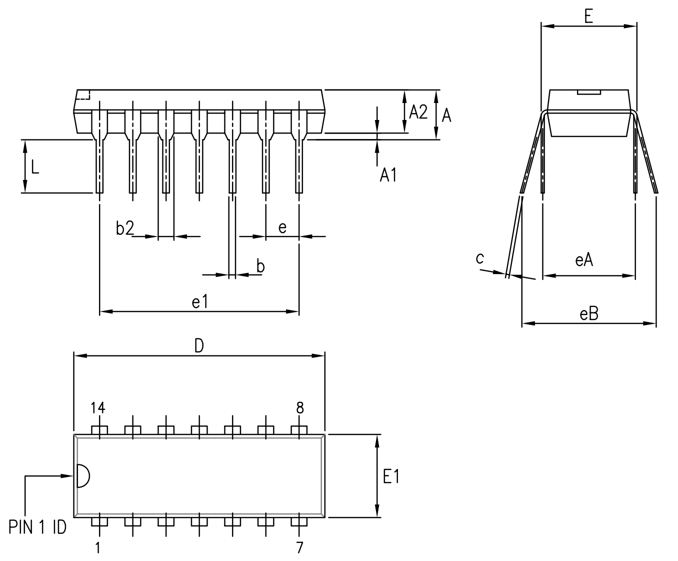


Table 4. DIP14 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			5.33			0.21
A1	0.38			0.015		
A2	2.92	3.30	4.95	0.11	0.13	0.19
b	0.36	0.46	0.56	0.014	0.018	0.022
b2	1.14	1.52	1.78	0.04	0.06	0.07
c	0.20	0.25	0.36	0.007	0.009	0.01
D	18.67	19.05	19.69	0.73	0.75	0.77
E	7.62	7.87	8.26	0.30	0.31	0.32
E1	6.10	6.35	7.11	0.24	0.25	0.28
e		2.54			0.10	
e1		15.24			0.60	
eA		7.62			0.30	
eB			10.92			0.43
L	2.92	3.30	3.81	0.11	0.13	0.15

Note: *D and E1 dimensions do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.25 mm.*

4.2 SO-14 package information

Figure 29. SO-14 package outline

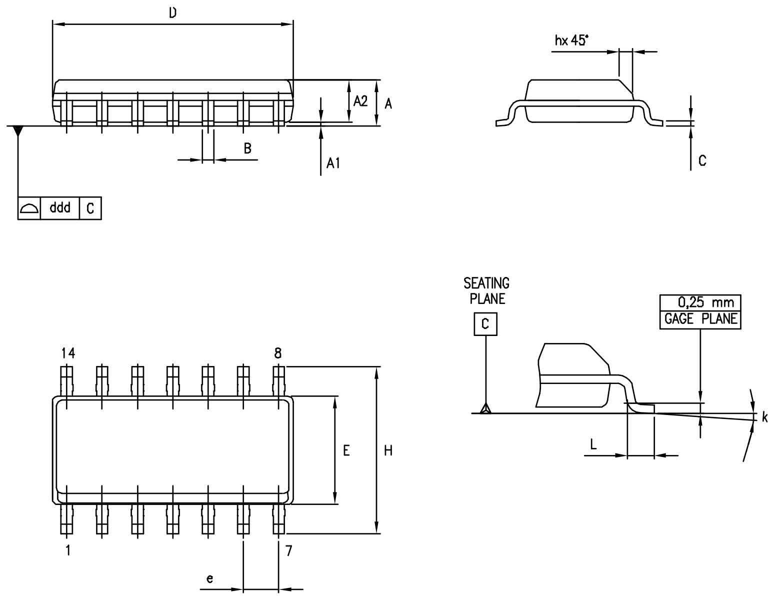


Table 5. SO-14 package mechanical data

Symbol	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	1.35		1.75	0.05		0.068
A1	0.10		0.25	0.004		0.009
A2	1.10		1.65	0.04		0.06
B	0.33		0.51	0.01		0.02
C	0.19		0.25	0.007		0.009
D	8.55		8.75	0.33		0.34
E	3.80		4.0	0.15		0.15
e		1.27			0.05	
H	5.80		6.20	0.22		0.24
h	0.25		0.50	0.009		0.02
L	0.40		1.27	0.015		0.05
k	8° (max.)					
ddd			0.10			0.004

Note: D and F dimensions do not include mold flash or protrusions. Mold flash or protrusions must not exceed 0.15 mm.

5 Ordering information

Table 6. Order codes

<table>
<tr><th>Order code</th><th>Temperature range</th><th>Package</th><th>Packaging</th><th>Marking</th></tr>
<tr><td>TS514IN</td><td rowspan="4">-40, + 125 °C</td><td rowspan="2">DIP14</td><td rowspan="2">Tube</td><td>TS514IN</td></tr>
<tr><td>TS514AIN</td><td>TS514AIN</td></tr>
<tr><td>TS514ID
TS514IDT</td><td rowspan="2">SO-14</td><td rowspan="2">Tube
or
tape and reel</td><td>514I</td></tr>
<tr><td>TS514AID
TS514AIDT</td><td>514AI</td></tr>
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6 Revision history

Table 7. Document revision history

Date	Revision	Changes
09-Mar-2001	1	Initial release.
23-Jun-2005	2	Automotive grade part references inserted in the datasheet (see *Chapter 5: Ordering information on page 14*).
30-Sep-2005	3	The following changes were made in this revision. – An error in the device description was corrected on page 1. – *Chapter 5: Ordering information on page 14* updated with complete list of markings. – Addition of supplementary data in *Table 1: Absolute maximum ratings on page 2*. – Addition of *Table 2: Operating conditions on page 2*. – Reorganization of *Chapter 4: Package information on page 11*. – Minor grammatical and formatting changes throughout.
24-Oct-2008	4	Added performance AC and DC characteristic curves for V_{CC}=6 V, V_{CC}=10 V and V_{CC}=30 V in *Chapter 3: Electrical characteristics*. Modified I_{CC} typ, added parameters over temperature in *Table 3*. Deleted old macromodel. Added R_{thjc}, R_{thja} in *Table 1*. Corrected V_i and V_{id} AMR values in *Table 1*. Added input common mode range V_{icm} in *Table 2: Operating conditions*. Updated *Section 4.1: DIP14 package information* and *Section 4.2: SO-14 package information*.
12-Sep-2012	5	Updated *Features* (removed “macromodel”). Updated CMR and SVR test conditions in *Table 3*. Updated ECOPACK text in *Section 4*. Removed TS514IYD, TS514IYDT, TS514AIYD, and TS514AIYDT order code from *Table 6*. Minor corrections throughout document.